

8961726 TEXAS INSTR (OPTO)

62C 36894 D

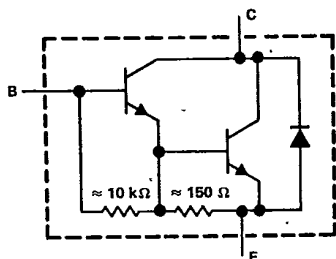
TIP120, TIP121, TIP122
N-P-N DARLINGTON-CONNECTED
SILICON POWER TRANSISTORS

REVISED OCTOBER 1984

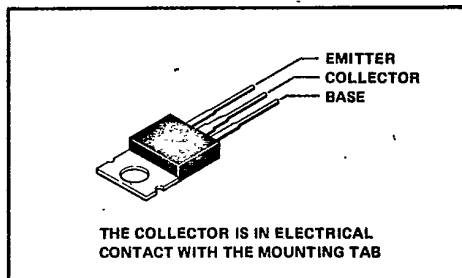
T-33-29

- Designed For Complementary use with TIP125, TIP126, TIP127
- 65 W at 25°C Case Temperature
- 5 A Rated Collector Current
- Min h_{FE} of 1000 at 3 V, 3 A
- 50 mJ Reverse Energy Rating

device schematic



TO-220AB PACKAGE



absolute maximum ratings at 25°C case temperature (unless otherwise noted)

	TIP120	TIP121	TIP122
Collector-base voltage	60 V	80 V	100 V
Collector-emitter voltage (I _B = 0)	60 V	80 V	100 V
Emitter-base voltage	5 V		
Continuous collector current	5 A		
Peak collector current (see Note 1)	8 A		
Continuous base current	0.1 A		
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)	65 W		
Continuous device dissipation at (or below) 25°C free-air temperature (see Note 3)	2 W		
Safe operating area at (or below) 25°C case temperature	See Figures 7 and 8		
Unclamped inductive load energy (see Note 4)	50 mJ		
Operating collector junction and storage temperature range	-65°C to 150°C		
Lead temperature 3,2 mm (0.125 inch) from case for 10 seconds	260°C		

- NOTES: 1. This value applies for t_w ≤ 0.3 ms, duty cycle ≤ 10%.
 2. Derate linearly to 150°C case temperature at the rate of 0.52 W/°C or refer to Dissipation Derating Curve, Figure 9.
 3. Derate linearly to 150°C free-air temperature at the rate of 16 mW/°C or refer to Dissipation Derating Curve, Figure 10.
 4. This rating is based on the capability of the transistor to operate safely in the circuit in Figure 2. L = 20 mH, R_{BB2} = 100 Ω, V_{BB2} = 0 V, R_S = 0.1 Ω, V_{CC} = 20 V. Energy ≈ I_C²L/2.



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electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS	TIP120			TIP121			TIP122			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
$V_{(BR)CEO}$	$I_C = 30\text{ mA}$, See Note 5 $I_B = 0$	60			80			100			V
I_{CEO}	$V_{CE} = 30\text{ V}$, $I_B = 0$	0.5			0.5			0.5			mA
	$V_{CE} = 40\text{ V}$, $I_B = 0$										
	$V_{CE} = 50\text{ V}$, $I_B = 0$										
I_{CBO}	$V_{CB} = 60\text{ V}$, $I_E = 0$	0.2			0.2			0.2			mA
	$V_{CB} = 80\text{ V}$, $I_E = 0$										
	$V_{CB} = 100\text{ V}$, $I_E = 0$										
I_{EBO}	$V_{EB} = 5\text{ V}$, $I_C = 0$	2			2			2			mA
h_{FE}	$V_{CE} = 3\text{ V}$, See Notes 5 and 6 $I_C = 0.5\text{ A}$	1000			1000			1000			
	$V_{CE} = 3\text{ V}$, See Notes 5 and 6 $I_C = 3\text{ A}$	1000			1000			1000			
$V_{CE(sat)}$	$I_B = 12\text{ mA}$, See Notes 5 and 6 $I_C = 3\text{ A}$	2			2			2			V
	$I_B = 20\text{ mA}$, See Notes 5 and 6 $I_C = 5\text{ A}$	4			4			4			
V_{BE}	$V_{CE} = 3\text{ V}$, See Notes 5 and 6 $I_C = 3\text{ A}$	2.5			2.5			2.5			V
V_F	$I_F = 5\text{ A}$, See Notes 5 and 6	3.5			3.5			3.5			V

- NOTES: 5. These parameters must be measured using pulse techniques, $t_w = 300\ \mu\text{s}$, duty cycle $\leq 2\%$.
6. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts located within 3.2 mm (0.125 inch) from the device body.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$			1.92	$^{\circ}\text{C/W}$
$R_{\theta JA}$			62.5	$^{\circ}\text{C/W}$

resistive-load switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS†	MIN	TYP	MAX	UNIT
t_{on}	$I_C = 3\text{ A}$, $I_{B1} = 12\text{ mA}$, $I_{B2} = -12\text{ mA}$	1.5			μs
t_{off}	$V_{BE(off)} = -5\text{ V}$, $R_L = 10\ \Omega$, See Figure 1	8.5			

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.



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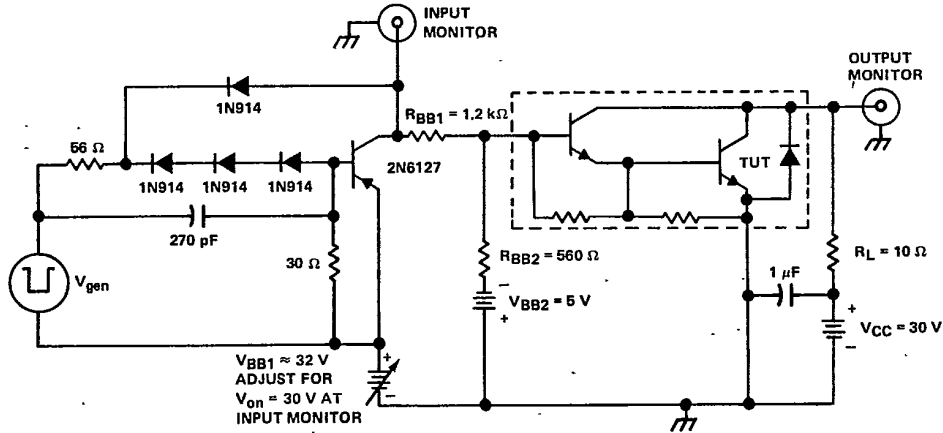
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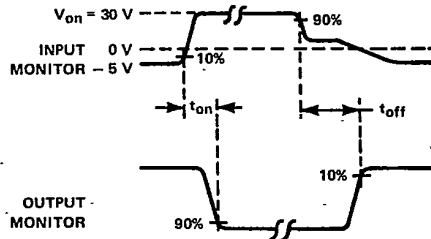
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PARAMETER MEASUREMENT INFORMATION

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TEST CIRCUIT



VOLTAGE WAVEFORMS

- NOTES:
- A. V_{gen} is a -30-V pulse into a $50\ \Omega$ termination.
 - B. The V_{gen} waveform is supplied by a generator with the following characteristics: $t_r \leq 15\text{ ns}$, $t_f \leq 15\text{ ns}$, $Z_{out} = 50\ \Omega$, $t_w = 20\ \mu\text{s}$, duty cycle $\leq 2\%$.
 - C. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r \leq 15\text{ ns}$, $R_{in} \geq 10\text{ M}\Omega$, $C_{in} \leq 11.5\text{ pF}$.
 - D. Resistors must be noninductive types.
 - E. The d-c power supplies may require additional bypassing in order to minimize ringing.

FIGURE 1. RESISTIVE-LOAD SWITCHING

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TIP Devices

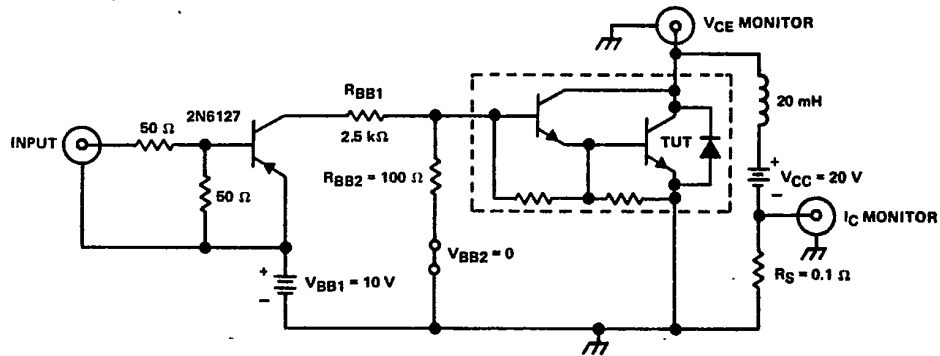
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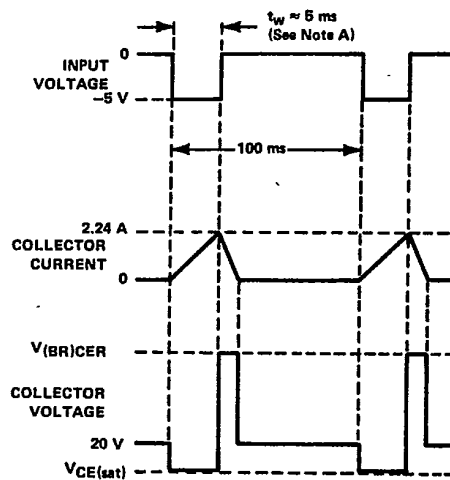
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PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



VOLTAGE AND CURRENT WAVEFORMS

NOTE A: Input pulse duration is increased until $I_{CM} = 2.24$ A.

FIGURE 2. INDUCTIVE-LOAD SWITCHING

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TYPICAL CHARACTERISTICS

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STATIC FORWARD CURRENT TRANSFER RATIO
vs
COLLECTOR CURRENT

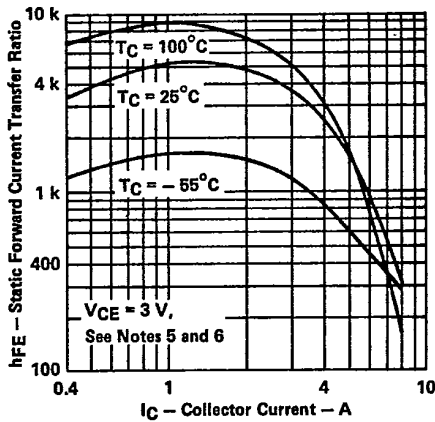


FIGURE 3

BASE-EMITTER VOLTAGE
vs
CASE TEMPERATURE

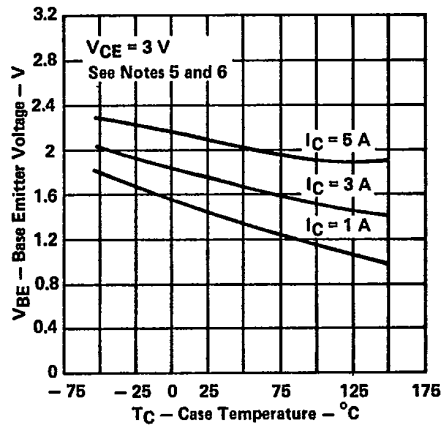


FIGURE 4

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
CASE TEMPERATURE

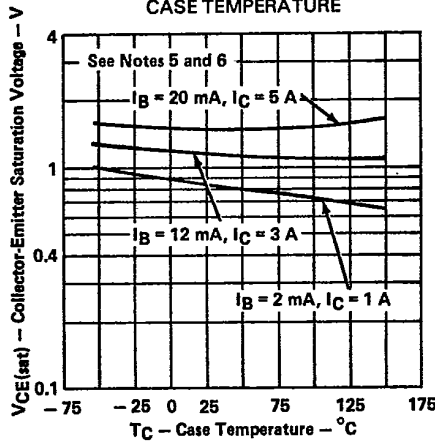


FIGURE 5

SMALL-SIGNAL COMMON-EMITTER
FORWARD CURRENT TRANSFER RATIO
vs
FREQUENCY

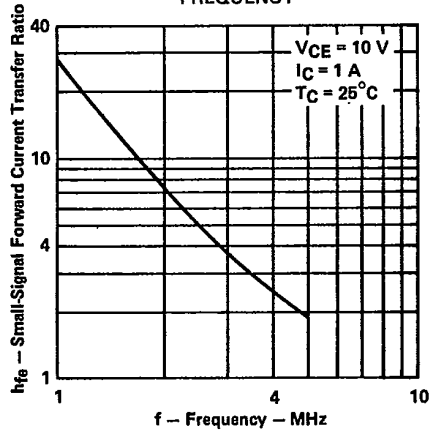


FIGURE 6

- NOTES: 5. These parameters must be measured using pulse techniques, $t_w = 300 \mu s$, duty cycle $\leq 2\%$.
6. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts located within 3,2 mm (0,125 inch) from the device body.



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MAXIMUM SAFE OPERATING AREA

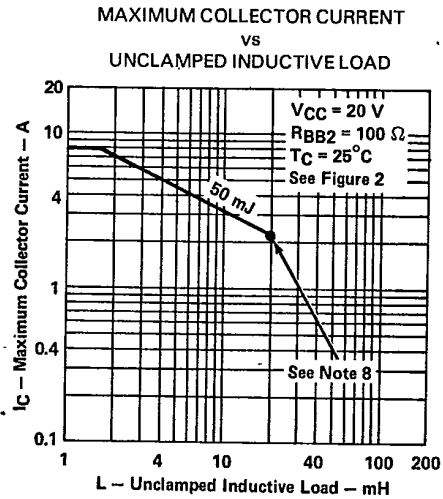
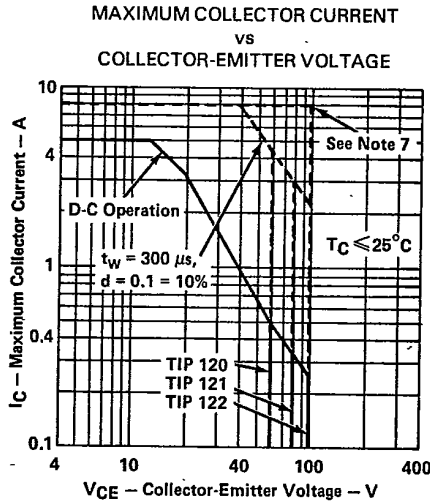


FIGURE 7

FIGURE 8

- NOTES: 7. This combination of maximum voltage and current may be achieved only when switching from saturation to cutoff with a clamped inductive load.
8. Above this point the safe operating area has not been defined.

THERMAL INFORMATION

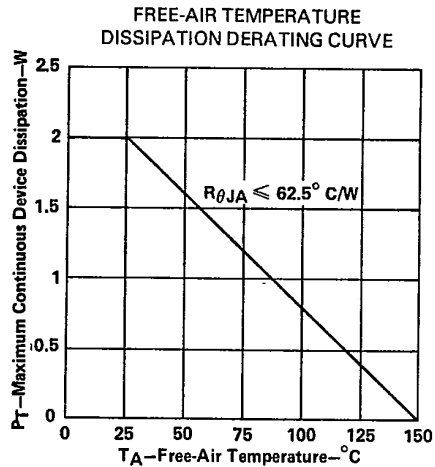
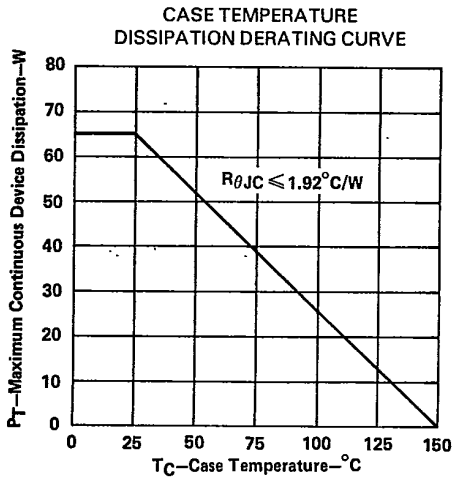


FIGURE 9

FIGURE 10

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